

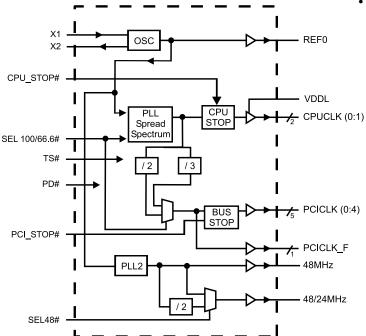
Frequency Timing Generator for Pentium II Systems

General Description

The ICS9248-56 is the Main clock solution for Notebook designs using the Intel 440BX style chipset. Along with an SDRAM buffer such as the ICS9179-03, it provides all necessary clock signals for such a system.

Spread spectrum may be enabled by driving pin 26, SPREAD# active (Low) at power-on. Spread spectrum typically reduces system EMI by 8dB to 10dB. This simplifies EMI qualification without resorting to board design iterations or costly shielding. The ICS9248-56 employs a proprietary closed loop design, which tightly controls the percentage of spreading over process and temperature variations.

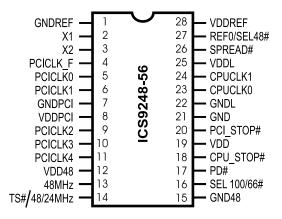
Block Diagram



Features

- Generates the following system clocks:
 - -2CPU(2.5V) up to 100MHz.
 - 6 PCI(3.3V) @ 33.3MHz (Includes one free running).
 - -1 REF clks (3.3V) at 14.318MHz.
 - 1 Fixed clock at 48MHz
 - 1 Fixed clock at 48 or 24MHz
- Skew characteristics:
 - -CPU-CPU≤175ps
 - $-PCI-PCI \le 500ps$
 - CPU(early) PCI = 1.5ns 4ns.
- Supports Spread Spectrum modulation for CPU and PCI clocks, 0.5% down spread
- Efficient Power management scheme through stop clocks and power down modes.
- Uses external 14.318MHz crystal, no external load cap required for CL=18pF crystal.
- 28 pin 209mil SSOP and 173mil TSSOP

Pin Configuration



28 pin SSOP and TSSOP

Power Groups

VDD, GND=PLL core VDDREF, GNDREF=REF(0:1), X1, X2 VDDPCI, GNDPCI=PCICLK_F, PCICLK (0:4) VDD48, GND48=48MHz, 48/24MHz

Pentium is a trademark on Intel Corporation.

ICS9248-56



Pin Descriptions

Pin number	Pin name	Туре	Description					
1	GNDREF	Power	Ground for 14.318 MHz reference clock outputs					
2	X1	Input	14.318 MHz crystal input					
3	X2	Output	14.318 MHz crystal output					
4	PCICLK_F	Output	3.3 V free running PCI clock output, will not be stopped by the PCI_STOP#					
5,6,9,10,11	PCICLK (1:5)	Output	3.3 V PCI clock outputs, generating timing requirements for Pentium II					
7	GNDPCI	Power	Ground for PCI clock outputs					
8	VDDPCI	Power	3.3 V power for the PCI clock outputs					
12	VDD48	Power	3.3 V power for 48/24 MHz clocks					
13	48 MHz	Output	3.3 V 48 MHz clock output, fixed frequency clock typically used with USB devices					
			3.3 V 48 or 24 MHz output and Tri-state option, active low = tri state mode for testing,					
14	TS#/48/24MHz	Output	active high = normal operation					
15	GND48	Power	Ground for 48/24 MHz clocks					
			control for the frequency of clocks at the CPU & PCICLK output pins. If logic "0" is					
40	051 400/00#	l	used the 66.6 MHz frequency is selected. If Logic "1" is used, the 100 MHz					
16	SEL 100/66#	Input	frequency is selected. The PCI clock is multiplexed to run at 33.3 MHz for both					
			selected cases.					
			Asynchronous active low input pin used to power down the device into a low power					
17	PD#		PD#	PD#	7 PD#	PD# Inp	Input	state. The internal clocks are disabled and the VCO and the crystal are stopped. The
			latency of the power down will not be greater than 3ms.					
			Asynchronous active low input pin used to stop the CPUCLK in active low state, all					
18	CPU_STOP#	Input	other clocks will continue to run. The CPUCLK will have a "Turnon " latency of at					
			least 3 CPU clocks.					
19	VDD	Power	Isolated 3.3 V power for core					
20	PCI-Stop#	Input	Synchronous active low input used to stop the PCICLK in active low state. It will not					
20	PCI-310p#	Input	effect PCICLK_F or any other outputs.					
21	GND	Power	Isolated ground for core					
22	GNDL	Power	Ground for CPU clock outputs					
23,24	CPUCLK(1:0)	Output	2.5 V CPU clock outputs					
25	VDDL	Power	2.5 V power for CPU clock outputs					
26	SPREAD#	Output	Power-on spread spectrum enable option. Active low = spread spectrum clocking					
20	OF NEAD#	Output	enable. Active high = spread spectrum clocking disable.					
27	REF0/SEL48#	Output	3.3 V 14.318 MHz reference clock output and power-on 48/24 MHz select option.					
21	NEI 0/3EE40#	Julpul	Active low = 48 MHz output at pin 14. Active high = 24 MHz output at pin 14.					
28	VDDREF	Power	3.3 V power for 14.318 MHz reference clock outputs.					



Select Functions

(Functionality determined by TS# and SEL100/66# pin, see below)

Functionality	CPUCLK	PCI, PCI_F	REF0
Tristate	HI - Z	HI - Z	HI - Z
Testmode	TCLK/21	TCLK/61	TCLK ¹

Notes:

1. TCLK is a test clock driven on the X1 (crystal in pin) input during test mode.

SEL 100/66#	TS#	Function			
0	0	Tri-State			
0	-	(Reserved)			
0	-	(Reserved)			
0	1	Active 66.6MHz CPU, 33.3 PCI			
1	0	Test Mode			
1	-	(Reserved)			
1	-	(Reserved)			
1	1	Active 100MHz CPU, 33.3 PCI			

Power Management

Clock Enable Configuration

CPU_STOP#	PCI_STOP#	PWR_DWN#	CPUCLK	PCICLK	PCICLK_F	REF	Crystal	VCOs
X	X	0	Low	Low	Low	Stopped	Off	Off
0	0	1	Low	Low	33.3MHz	Running	Running	Running
0	1	1	Low	33.3 MHz	33.3MHz	Running	Running	Running
1	0	1	100/66.6MHz	Low	33.3MHz	Running	Running	Running
1	1	1	100/66.6MHz	33.3 MHz	33.3MHz	Running	Running	Running

Full clock cycle timing is guaranteed at all times after the system has initially powered up except where noted. During power up and power down operations using the PD# pin will not cause clocks of a short or longer pulse than that of the running clock. The first clock pulse coming out of a stopped clock condition may be slightly distorted due to clock network charging circuitry. Board routing and signal loading may have a large impact on the initial clock distortion also.

ICS9248-56 Power Management Requirements

	. 8	
SIGNAL	SIGNAL STATE	Latency No. of rising edges of free running PCICLK
CPU_ STOP#	0 (Disabled) ²	1
	1 (Enabled) ¹	1
PCI_STOP#	0 (Disabled) ²	1
	1 (Enabled) ¹	1
PD# 1 (Normal Operat		3ms
	0 (Power Down) ⁴	2max

Notes.

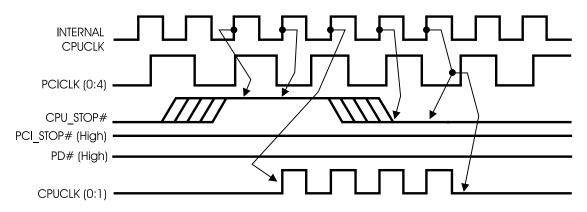
- 1. Clock on latency is defined from when the clock enable goes active to when the first valid clock comes out of the device.
- 2. Clock off latency is defined from when the clock enable goes inactive to when the last clock is driven low out of the device.
- 3. Power up latency is when PD# goes inactive (high) to when the first valid clocks are output by the device.
- 4. Power down has controlled clock counts applicable to CPUCLK, PCICLK only.

The REF will be stopped independant of these.



CPU_STOP#Timing Diagram

CPUSTOP# is an asychronous input to the clock synthesizer. It is used to turn off the CPUCLKs for low power operation. CPU_STOP# is synchronized by the **ICS9248-56**. The minimum that the CPUCLK is enabled (CPU_STOP# high pulse) is 100 CPUCLKs. All other clocks will continue to run while the CPUCLKs are disabled. The CPUCLKs will always be stopped in a low state and start in such a manner that guarantees the high pulse width is a full pulse. CPUCLK on latency is less than 4 CPUCLKs and CPUCLKs and CPUCLKs.

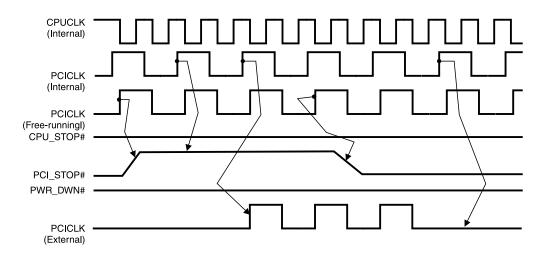


Notes:

- 1. All timing is referenced to the internal CPUCLK.
- CPU_STOP# is an asynchronous input and metastable conditions may exist. This signal is synchronized to the CPUCLKs inside the ICS9248-56.
- 3. All other clocks continue to run undisturbed.
- 4. PD# and PCI_STOP# are shown in a high (true) state.

PCI_STOP#Timing Diagram

PCI_STOP# is an asynchronous input to the **ICS9248-56**. It is used to turn off the PCICLK (0:4) clocks for low power operation. PCI_STOP# is synchronized by the **ICS9248-56** internally. The minimum that the PCICLK (0:4) clocks are enabled (PCI_STOP# high pulse) is at least 10 PCICLK (0:4) clocks. PCICLK (0:4) clocks are stopped in a low state and started with a full high pulse width guaranteed. PCICLK (0:4) clock on latency cycles are only one rising PCICLK clock off latency is one PCICLK clock.



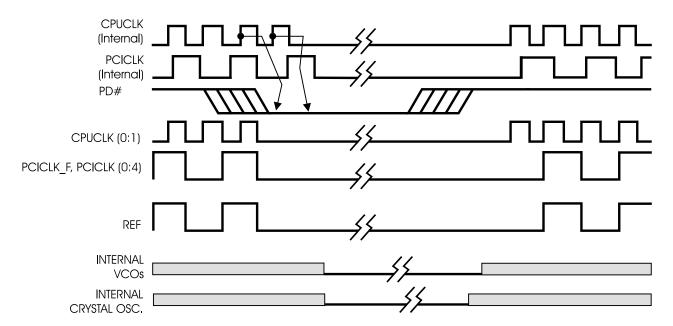
Notes:

- 1. All timing is referenced to the Internal CPUCLK (defined as inside the ICS9248 device.)
- 2. PCI_STOP# is an asynchronous input, and metastable conditions may exist. This signal is required to be synchronized inside the ICS9248.
- 3. All other clocks continue to run undisturbed.
- 4. PD# and CPU_STOP# are shown in a high (true) state.



PD#Timing Diagram

The power down selection is used to put the part into a very low power state without turning off the power to the part. PD# is an asynchronous active low input. This signal is synchronized internally by the ICS9248-56 prior to its control action of powering down the clock synthesizer. Internal clocks will not be running after the device is put in power down state. When PD# is active (low) all clocks are driven to a low state and held prior to turning off the VCOs and the crystal oscillator. The power on latency is guaranteed to be less than 3ms. The power down latency is less than three CPUCLK cycles. PCI_STOP# and CPU_STOP# are don't care signals during the power down operations.



Notes:

- 1. All timing is referenced to the Internal CPUCLK (defined as inside the ICS9248 device).
- 2. PD# is an asynchronous input and metastable conditions may exist. This signal is synchronized inside the ICS9248.
- 3. The shaded sections on the VCO and the Crystal signals indicate an active clock is being generated.

ICS9248-56



Absolute Maximum Ratings

Supply Voltage 7.0 V

Ambient Operating Temperature 0°C to +70°C

Storage Temperature -65° C to $+150^{\circ}$ C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Electrical Characteristics - Input/Supply/Common Output Parameters $T_A = 0$ - 70C; Supply Voltage $V_{DD} = V_{DDL} = 3.3 \text{ V}$ +/-5% (unless otherwise stated)

SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
${ m V}_{ m IH}$		2		$V_{DD}+0.3$	V
$V_{ m IL}$		V_{SS} -0.3		0.8	V
${ m I}_{ m IH}$	$V_{IN} = V_{DD}$		0.1	5	μ^{A}
I_{IL1}	$V_{IN} = 0 \text{ V}$; Inputs with no pull-up resistors	-5	2.0		μ^{A}
$I_{\rm IL2}$	$V_{IN} = 0 \text{ V}$; Inputs with pull-up resistors	-200	-100		μ^{A}
$I_{DD3.3OP66}$	$C_L = 0 \text{ pF}$; Select @ 66MHz		60	180	mA
$I_{DD3.3OP100}$	$C_L = 0 \text{ pF}$; Select @ 100MHz		66	180	mA
$I_{DD3.3PD}$	$C_L = 0 \text{ pF}$; With input address to Vdd or GND		70	600	μ^{A}
F_{i}	$V_{DD} = 3.3 \text{ V};$	11	14.318	16	MHz
C_{IN}	Logic Inputs			5	pF
C_{INX}	X1 & X2 pins	27	36	45	pF
T_{trans}	To 1st crossing of target Freq.		_	3	ms
T_{STAB}	From $V_{DD} = 3.3 \text{ V}$ to 1% target Freq.			3	ms
$T_{CPU ext{-}PCI}$	$V_{T} = 1.5 \text{ V};$	1.5	2.4	4	ns
	$\begin{array}{c} V_{IH} \\ V_{IL} \\ I_{IH} \\ I_{IL1} \\ I_{IL2} \\ I_{DD3.3OP66} \\ I_{DD3.3OP100} \\ I_{DD3.3PD} \\ \\ \hline F_i \\ C_{IN} \\ C_{INX} \\ T_{trans} \\ T_{STAB} \\ \hline \end{array}$	$\begin{array}{c c} V_{IH} \\ \hline V_{IL} \\ \hline I_{IH} & V_{IN} = V_{DD} \\ \hline I_{IL1} & V_{IN} = 0 \text{ V}; \text{ Inputs with no pull-up resistors} \\ \hline I_{IL2} & V_{IN} = 0 \text{ V}; \text{ Inputs with pull-up resistors} \\ \hline I_{DD3.30P66} & C_L = 0 \text{ pF}; \text{ Select @ 66MHz} \\ \hline I_{DD3.3OP100} & C_L = 0 \text{ pF}; \text{ Select @ 100MHz} \\ \hline I_{DD3.3PD} & C_L = 0 \text{ pF}; \text{ With input address to Vdd or GND} \\ \hline F_i & V_{DD} = 3.3 \text{ V}; \\ \hline C_{IN} & \text{Logic Inputs} \\ \hline C_{INX} & X1 \& X2 \text{ pins} \\ \hline T_{trans} & \text{To 1st crossing of target Freq.} \\ \hline T_{STAB} & \text{From V}_{DD} = 3.3 \text{ V to 1\% target Freq.} \\ \hline \end{array}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

Guaranteed by design, not 100% tested in production.

Electrical Characteristics - Input/Supply/Common Output Parameters

 $T_A = 0$ - 70C; Supply Voltage $V_{DD} = 3.3 \text{ V} + /-5\%$, $V_{DDL} = 2.5 \text{ V} + /-5\%$ (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating	$I_{\mathrm{DD2.5OP66}}$	$C_L = 0$ pF; Select @ 66.8 MHz		16	72	mA
Supply Current	$I_{\mathrm{DD2.5OP100}}$	$C_L = 0 \text{ pF}$; Select @ 100 MHz		23	100	mA
Skew ¹	t _{CPU-PCI2}	$V_T = 1.5 \text{ V}; V_{TL} = 1.25 \text{ V}$	1.5	3	4	ns

¹Guaranteed by design, not 100% tested in production.



Electrical Characteristics - CPUCLK $T_A = 0$ - 70C; $V_{DD} = 3.3$ V +/-5%, $V_{DDL} = 2.5$ V +/-5%; $C_L = 10$ - 20 pF (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output High Voltage	V_{OH2B}	$I_{OH} = -12.0 \text{ mA}$	1.8	2.3		V
Output Low Voltage	V_{OL2B}	$I_{OL} = 12 \text{ mA}$		0.31	0.4	V
Output High Current	I_{OH2B}	$V_{OH} = 1.7 \text{ V}$			-27	mA
Output Low Current	I_{OL2B}	$V_{OL} = 0.7 \text{ V}$	27			mA
Rise Time	t_{r2B}^{-1}	$V_{OL} = 0.4 \text{ V}, V_{OH} = 2.0 \text{ V}$	0.4	1.15	1.6	ns
Fall Time	t_{f2B}^1	$V_{OH} = 2.0 \text{ V}, V_{OL} = 0.4 \text{ V}$	0.4	1.4	1.6	ns
Duty Cycle	d_{t2B}^{-1}	$V_{T} = 1.25 \text{ V}$	44	48	55	%
Skew	t_{sk2B}^{-1}	$V_{\rm T} = 1.25 \text{ V}$		134	175	ps
	t _{jcyc-cyc2B} 1	$V_{T} = 1.25 \text{ V}$		186	250	ps
Jitter	t_{j1s2B}^{1}	$V_{T} = 1.25 \text{ V}$		52	150	ps
	t _{jabs2B}	$V_T = 1.25 \text{ V}$	-250	150	+250	ps

¹Guaranteed by design, not 100% tested in production.

Electrical Characteristics - PCICLK

 T_A = 0 - 70C; V_{DD} = V_{DDL} = 3.3 V +/-5%; C_L = 30 pF

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output High Voltage	V_{OH1}	$I_{OH} = -18 \text{ mA}$	2.1	3.3		V
Output Low Voltage	V_{OL1}	$I_{OL} = 9.4 \text{ mA}$		0.1	0.4	V
Output High Current	I_{OH1}	$V_{OH} = 2.0 \text{ V}$			-22	mA
Output Low Current	I_{OL1}	$V_{OL} = 0.8 \text{ V}$	16		57	mA
Rise Time ¹	t_{r1}	$V_{OL} = 0.4 \text{ V}, V_{OH} = 2.4 \text{ V}$		1.6	2	ns
Fall Time ¹	$t_{\rm f1}$	$V_{OH} = 2.4 \text{ V}, V_{OL} = 0.4 \text{ V}$		1.8	2	ns
Duty Cycle ¹	d_{t1}	$V_T = 1.5 \text{ V}$	45	50	55	%
Skew ¹	t_{sk1}	$V_T = 1.5 \text{ V}$		222	500	ps
	t _{jeye-eye} 1	$V_{\rm T} = 1.5 \text{ V}$		186	500	ps
Jitter	t_{j1s1}	$V_T = 1.5 \text{ V}$		52	150	ps
	$t_{\rm jabs1}$	$V_T = 1.5 \text{ V}$		200	500	ps

¹Guaranteed by design, not 100% tested in production.



Electrical Characteristics - REF/48MHz/24MHz

 $T_A = 0 - 70C$; $V_{DD} = V_{DDL} = 3.3 \text{ V +/-5\%}$; $C_L = 10 - 20 \text{ pF}$ (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output High Voltage	V_{OH5}	$I_{OH} = -12 \text{ mA}$	2.6	3.1		V
Output Low Voltage	V_{OL5}	$I_{OL} = 9 \text{ mA}$		0.17	0.4	V
Output High Current	I_{OH5}	$V_{OH} = 2.0 \text{ V}$		-44	-22	mA
Output Low Current	I_{OL5}	$V_{OL} = 0.8 \text{ V}$	16	42		mA
Rise Time ¹	t _{r5}	$V_{OL} = 0.4 \text{ V}, V_{OH} = 2.4 \text{ V}$		1.4	4	ns
Fall Time ¹	$t_{ m f5}$	$V_{OH} = 2.4 \text{ V}, V_{OL} = 0.4 \text{ V}$		1.1	4	ns
Duty Cycle ¹	d _{t5}	$V_T = 1.5 \text{ V}$	45	53	55	%
Jitter ¹	t _{j1σ5}	$V_T = 1.5 \text{ V, REF}$		185	250	ps
Jitter	t _{jabs5}	$V_T = 1.5 \text{ V, REF}$		385	800	ps
Jitter ¹	t _{j1σ5}	$V_T = 1.5 \text{ V}, 48 \text{ MHz}$		169	250	ps
Jitter	t _{jabs5}	$V_T = 1.5 \text{ V}, 48 \text{ MHz}$		469	800	ps

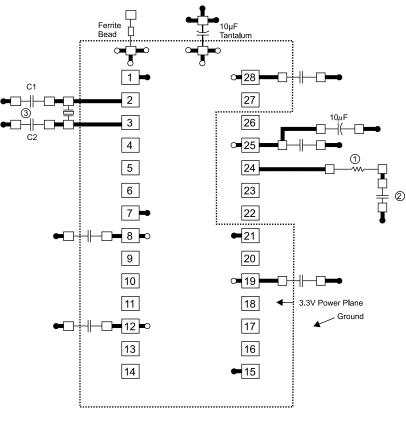


General Layout Precautions:

- 1) Use a ground plane on the top layer of the PCB in all areas not used by traces.
- 2) Make all power traces and vias as wide as possible to lower inductance.

Notes:

- 1 All clock outputs should have series terminating resistor. Not shown in all places to improve readibility of diagram
- 2 Optional EMI capacitor should be used on all CPU, SDRAM, and PCI outputs.
- 3 Optional crystal load capacitors are recommended.



= Ground Plane Connection

O = Power Plane Conncetion

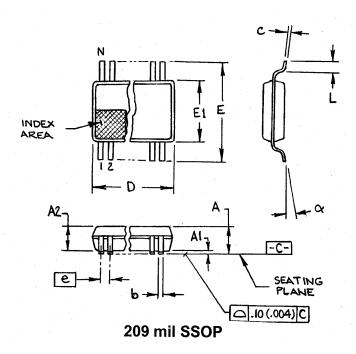
 ☐ = Solder Pads

Capacitor Values:

C1, C2: Crystal load values determined by user

All unmarked capacitors are 0.01 F ceramic





SYMBOL	In Milli		In Inches		
	COMMON D	IMENSIONS	COMMON DIMENSIONS		
	MIN	MAX	MIN	MAX	
Α	-	2.00	1	.079	
A1	0.05	-	.002	-	
A2	1.65	1.85	.065	.073	
b	0.22	0.38	.009	.015	
С	0.09	0.25	.0035	.010	
D	SEE VAR	IATIONS	SEE VARIATIONS		
Е	7.40	8.20	.291	.323	
E1	5.00	5.60	.197	.220	
е	0.65 E	BASIC	0.0256	BASIC	
L	0.55	0.95	.022	.037	
N	SEE VAR	IATIONS	SEE VAR	RIATIONS	
α	0°	8°	0°	8°	

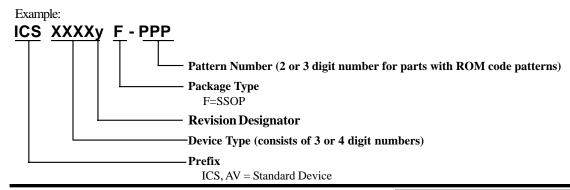
VARIATIONS

N	D m	nm.	D (inch)		
IN	MIN	MAX	MIN	MAX	
28	9.90	10.50	.390	.413	
			MO-150 JEDEC	6/1/00 Rev B	

MO-150 JEDEC

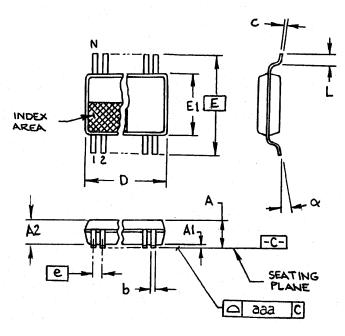
Ordering Information

ICS9248F-56



ICS reserves the right to make changes in the device data identified in this publication without further notice. ICS advises its customers to obtain the latest version of all device data to verify that any information being relied upon by the customer is current and accurate.





4.40 mm. Body, 0.65 mm. pitch TSSOP (173 mil) (0.0256 mil)

SYMBOL	In Millimeters COMMON DIMENSIONS		In Inches COMMON DIMENSIONS	
	MIN			MAX
Α	-	1.20	-	.047
A1	0.05	0.15	.002	.006
A2	0.80	1.05	.032	.041
b	0.19	0.30	.007	.012
С	0.09	0.20	.0035	.008
D	SEE VARIATIONS		SEE VARIATIONS	
Е	6.40 BASIC		0.252 BASIC	
E1	4.30	4.50	.169	.177
е	0.65 BASIC		0.0256 BASIC	
L	0.45	0.75	.018	.030
N	SEE VARIATIONS		SEE VARIATIONS	
α	0°	8°	0°	8°
aaa	-	0.10	-	.004

VARIATIONS

N	D mm.		D (inch)	
	MIN	MAX	MIN	MAX
28	9.60	9.80	.378	.386
•			MO AFO IF DE O	7///00 D D

MO-153 JE DE C 7/6/

Ordering Information

ICS9248<u>y</u>G-56-T

